

Z8400/Z84C00 NMOS/CMOS Z80® CPU Central Processing Unit

FEATURES

The extensive instruction set contains 158 instructions, including the 8080A instruction set as a subset.

- NMOS version for low cost high performance solutions, CMOS version for high performance low power designs.
- NMOS Z8400004 - 4 MHz, Z8400006 - 6.17 MHz, Z8400008 - 8 MHz.
- CMOS Z84C0006 - DC to 6.17 MHz, Z84C0008 - DC to 8 MHz, Z84C0010 - DC to 10 MHz, Z84C0020 - DC to 20 MHz
- 6 MHz version can be operated at 6.144 MHz clock.

- The Z80 microprocessors and associated family of peripherals can be linked by a vectored interrupt system. This system can be daisy-chained to allow implementation of a priority interrupt scheme.
- Duplicate set of both general-purpose and flag registers.
- Two sixteen-bit index registers.
- Three modes of maskable interrupts:
Mode 0—8080A similar;
Mode 1—Non-Z80 environment, location 38H;
Mode 2—Z80 family peripherals, vectored interrupts.
- On-chip dynamic memory refresh counter.

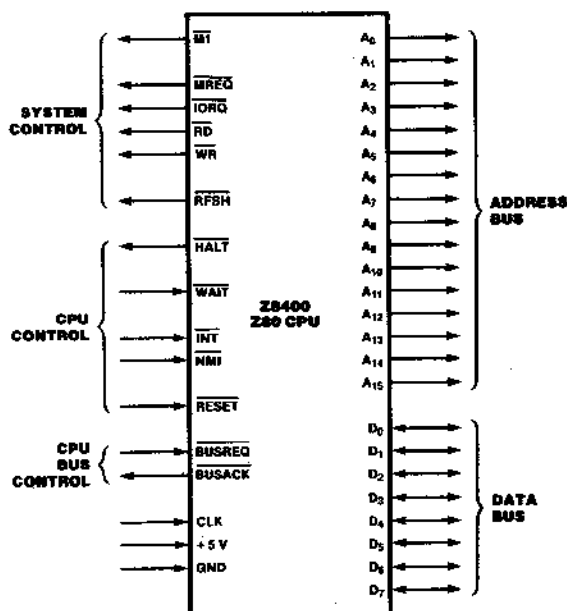


Figure 1. Pin Functions

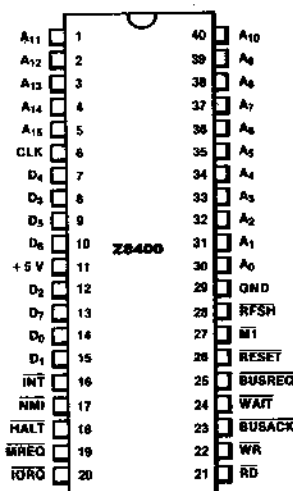
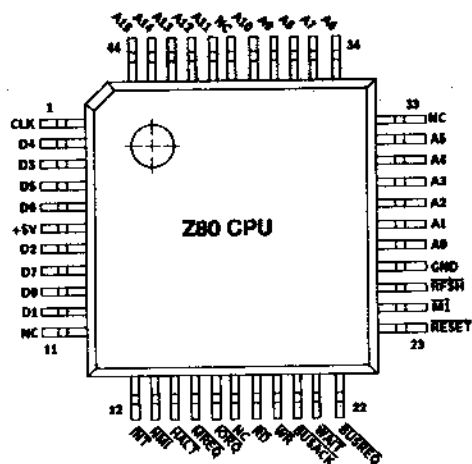


Figure 2. 40-pin Dual-In-Line (DIP), Pin Assignments



44 pin Quad Flat Pack (QFP), Pin Assignments
(Only available for 84C00)

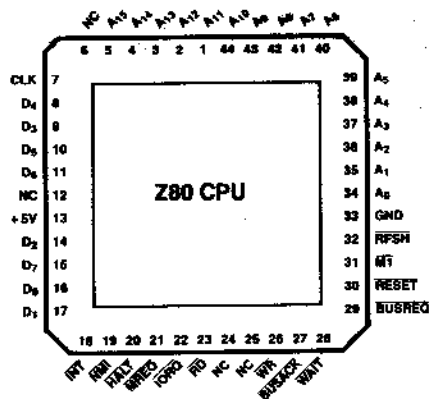


Figure 2b. 44-Pin Chip Carrier Pin Assignments

GENERAL DESCRIPTION

The CPUs are fourth-generation enhanced microprocessors with exceptional computational power. They offer higher system throughput and more efficient memory utilization than comparable second- and third-generation microprocessors. The internal registers contain 208 bits of read/write memory that are accessible to the programmer. These registers include two sets of six general-purpose registers which may be used individually as either 8-bit registers or as 16-bit register pairs. In addition, there are two sets of accumulator and flag registers. A group of "Exchange" instructions makes either set of main or alternate registers accessible to the programmer. The alternate set allows operation in foreground-background mode or it may be reserved for very fast interrupt response.

The CPU also contains a Stack Pointer, Program Counter, two index registers, a Refresh register (counter), and an Interrupt register. The CPU is easy to incorporate into a system since it requires only a single +5V power source. All output signals are fully decoded and timed to control standard memory or peripheral circuits; the CPU is supported by an extensive family of peripheral controllers. The internal block diagram (Figure 3) shows the primary functions of the processors. Subsequent text provides more detail on the I/O controller family, registers, instruction set, interrupts and daisy chaining, and CPU timing.

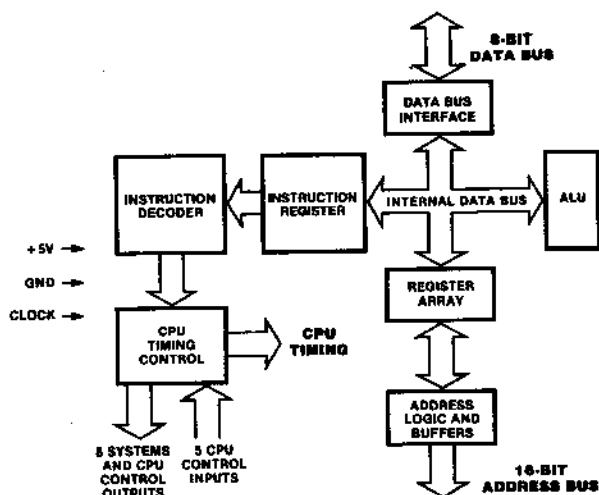


Figure 3. Z80C CPU Block Diagram

Table 1. Z80C CPU Registers

Register		Size (Bits)	Remarks
A, A'	Accumulator	8	Stores an operand or the results of an operation.
F, F'	Flags	8	See Instruction Set.
B, B'	General Purpose	8	Can be used separately or as a 16-bit register with C.
C, C'	General Purpose	8	Can be used separately or as a 16-bit register with B.
D, D'	General Purpose	8	Can be used separately or as a 16-bit register with E.
E, E'	General Purpose	8	Can be used separately or as a 16-bit register with D.
H, H'	General Purpose	8	Can be used separately or as a 16-bit register with L.
L, L'	General Purpose	8	Can be used separately or as a 16-bit register with H.
Note: The (B,C), (D,E), and (H,L) sets are combined as follows:			
B — High byte C — Low byte			
D — High byte E — Low byte			
H — High byte L — Low byte			
I	Interrupt Register	8	Stores upper eight bits of memory address for vectored interrupt processing.
R	Refresh Register	8	Provides user-transparent dynamic memory refresh. Automatically incremented and placed on the address bus during each instruction fetch cycle.
IX	Index Register	16	Used for indexed addressing.
IY	Index Register	16	Used for indexed addressing
SP	Stack Pointer	16	Holds address of the top of the stack. See Push or Pop in instruction set.
PC	Program Counter	16	Holds address of next instruction.
IFF ₁ -IFF ₂	Interrupt Enable	Flip-Flops	Set or reset to indicate interrupt status (see Figure 4).
IMFa-IMFb	Interrupt Mode	Flip-Flops	Reflect Interrupt mode (see Figure 4).

failure has been detected. After recognition of the **NMI** signal (providing **BUSREQ** is not active), the CPU jumps to restart location 0066H. Normally, software starting at this address contains the interrupt service routine.

Maskable Interrupt (INT). Regardless of the interrupt mode set by the user, the CPU response to a maskable interrupt input follows a common timing cycle. After the interrupt has been detected by the CPU (provided that interrupts are enabled and **BUSREQ** is not active) a special interrupt processing cycle begins. This is a special fetch (**M1**) cycle in which **IORQ** becomes active rather than **MREQ**, as in a normal **M1** cycle. In addition, this special **M1** cycle is automatically extended by two **WAIT** states, to allow for the time required to acknowledge the interrupt request.

Mode 0 Interrupt Operation. This mode is similar to the 8080 microprocessor interrupt service procedures. The interrupting device places an instruction on the data bus. This is normally a Restart instruction, which will initiate a call

to the selected one of eight restart locations in page zero of memory. Unlike the 8080, the Z80 CPU responds to the Call instruction with only one interrupt acknowledge cycle followed by two memory read cycles.

Mode 1 Interrupt Operation. Mode 1 operation is very similar to that for the **NMI**. The principal difference is that the Mode 1 interrupt has only one restart location, 0038H.

Mode 2 Interrupt Operation. This interrupt mode has been designed to most effectively utilize the capabilities of the Z80 microprocessor and its associated peripheral family. The interrupting peripheral device selects the starting address of the interrupt service routine. It does this by placing an 8-bit vector on the data bus during the interrupt acknowledge cycle. The CPU forms a pointer using this byte as the lower 8 bits and the contents of the I register as the upper 8 bits. This points to an entry in a table of addresses for interrupt service routines. The CPU then jumps to the routine at that

address. This flexibility in selecting the interrupt service routine address allows the peripheral device to use several different types of service routines. These routines may be located at any available location in memory. Since the interrupting device supplies the low-order byte of the 2-byte vector, bit 0 (A_0) must be a zero.

Interrupt Enable/Disable Operation. Two flip-flops, IFF₁ and IFF₂, referred to in the register description, are used to signal the CPU interrupt status. Operation of the two flip-flops is described in Table 2. For more details, refer to the *Z80 CPU Technical Manual* (03-0029-01) and *Z80 Assembly Language Programming Manual* (03-0002-01).

Table 2. State of Flip-Flops

Action	IFF ₁	IFF ₂	Comments
CPU Reset	0	0	Maskable interrupt INT disabled
DI instruction execution	0	0	Maskable interrupt INT disabled
EI instruction execution	1	1	Maskable interrupt INT enabled
LD A,I instruction execution	•	•	IFF ₂ → Parity flag
LD A,R instruction execution	•	•	IFF ₂ → Parity flag
Accept NMI	0	•	Maskable interrupt INT disabled
RETN instruction execution	IFF ₂	•	IFF ₂ → IFF ₁ at completion of an NMI service routine.

INSTRUCTION SET

The microprocessor has one of the most powerful and versatile instruction sets available in any 8-bit microprocessor. It includes such unique operations as a block move for fast, efficient data transfers within memory, or between memory and I/O. It also allows operations on any bit in any location in memory.

The following is a summary of the instruction set which shows the assembly language mnemonic, the operation, the flag status, and gives comments on each instruction. For an explanation of flag notations and symbols for mnemonic tables, see the Symbolic Notations section which follows these tables. The *Z80 CPU Technical Manual* (03-0029-01), the *Programmer's Reference Guide* (03-0012-03), and *Assembly Language Programming Manual* (03-0002-01) contain significantly more details for programming use.

The instructions are divided into the following categories:

- ☐ 8-bit loads
- ☐ 16-bit loads
- ☐ Exchanges, block transfers, and searches
- ☐ 8-bit arithmetic and logic operations
- ☐ General-purpose arithmetic and CPU control
- ☐ 16-bit arithmetic operations
- ☐ Rotates and shifts

- ☐ Bit set, reset, and test operations
- ☐ Jumps
- ☐ Calls, returns, and restarts
- ☐ Input and output operations

A variety of addressing modes are implemented to permit efficient and fast data transfer between various registers, memory locations, and input/output devices. These addressing modes include:

- ☐ Immediate
- ☐ Immediate extended
- ☐ Modified page zero
- ☐ Relative
- ☐ Extended
- ☐ Indexed
- ☐ Register
- ☐ Register indirect
- ☐ Implied
- ☐ Bit

8-BIT LOAD GROUP

Mnemonic	Symbolic Operation	S	Z	Flags				Opcode			Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments	
				H	P/V	N	C	76	543	210						
LD r, r'	r ← r'	•	•	X	•	X	•	•	01	r	r'	1	1	4	r, r' Reg.	
LD r, n	r ← n	•	•	X	•	X	•	•	00	r	110	2	2	7	000 B	
									← n →						001 C	
LD r, (HL)	r ← (HL)	•	•	X	•	X	•	•	01	r	110	1	2	7	010 D	
LD r, (IX+d)	r ← (IX+d)	•	•	X	•	X	•	•	11	011	101	DD	3	5	19	011 E
									01	r	110				100 H	
									← d →						101 L	
LD r, (IY+d)	r ← (IY+d)	•	•	X	•	X	•	•	11	111	101	FD	3	5	19	111 A
									01	r	110					
									← d →							
LD (HL), r	(HL) ← r	•	•	X	•	X	•	•	01	110	r	1	2	7		
LD (IX+d), r	(IX+d) ← r	•	•	X	•	X	•	•	11	011	101	DD	3	5	19	
									01	110	r					
									← d →							
LD (IY+d), r	(IY+d) ← r	•	•	X	•	X	•	•	11	111	101	FD	3	5	19	
									01	110	r					
									← d →							
LD (HL), n	(HL) ← n	•	•	X	•	X	•	•	00	110	110	36	2	3	10	
									← n →							
LD (IX+d), n	(IX+d) ← n	•	•	X	•	X	•	•	11	011	101	DD	4	5	19	
									00	110	110	36				
									← d →							
									← n →							

8-BIT LOAD GROUP (Continued)

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	76	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments	
LD (Y+d), n	(Y+d) ← n	•	•	X	•	X	•	•	•	•	11 111 101 00 110 110	FD 36	4	5	19	
											←d→ ←n→					
LD A, (BC)	A ← (BC)	•	•	X	•	X	•	•	•	•	00 001 010	0A	1	2	7	
LD A, (DE)	A ← (DE)	•	•	X	•	X	•	•	•	•	00 011 010	1A	1	2	7	
LD A, (nn)	A ← (nn)	•	•	X	•	X	•	•	•	•	00 111 010	3A	3	4	13	
											←n→ ←n→					
LD (BC), A	(BC) ← A	•	•	X	•	X	•	•	•	•	00 000 010	02	1	2	7	
LD (DE), A	(DE) ← A	•	•	X	•	X	•	•	•	•	00 010 010	12	1	2	7	
LD (nn), A	(nn) ← A	•	•	X	•	X	•	•	•	•	00 110 010	32	3	4	13	
											←n→ ←n→					
LDA, I	A ← I	†	†	X	0	X	IFF	0	•	•	11 101 101 01 010 111	ED 57	2	2	9	
LDA, R	A ← R	†	†	X	0	X	IFF	0	•	•	11 101 101 01 011 111	ED 5F	2	2	9	
LDI, A	I ← A	•	•	X	•	X	•	•	•	•	11 101 101 01 000 111	ED 47	2	2	9	
LDR, A	R ← A	•	•	X	•	X	•	•	•	•	11 101 101 01 001 111	ED 4F	2	2	9	

NOTE: IFF, the content of the interrupt enable flip-flop, (IFF₂), is copied into the P/V flag.

16-BIT LOAD GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	76	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments		
LD dd, nn	dd ← nn	•	•	X	•	X	•	•	00	dd0	001	3	3	10	dd	Pair	
									←n→						00	BC	
									←n→						01	DE	
LD IX, nn	IX ← nn	•	•	X	•	X	•	•	11	011	101	DD	4	4	14	10	HL
								00	100	001	21				11	SP	
									←n→								
									←n→								
LD IY, nn	IY ← nn	•	•	X	•	X	•	•	11	111	101	FD	4	4	14		
								00	100	001	21						
									←n→								
									←n→								
LD HL, (nn)	H ← (nn+1)	•	•	X	•	X	•	•	00	101	010	2A	3	5	16		
	L ← (nn)								←n→								
									←n→								
LD dd, (nn)	dd _H ← (nn+1)	•	•	X	•	X	•	•	11	101	101	ED	4	6	20		
	dd _L ← (nn)							01	dd1	011							
									←n→								
									←n→								

NOTE: (PAIR)_H, (PAIR)_L refer to high order and low order eight bits of the register pair respectively. e.g., BC_L = C, AF_H = A.

16-BIT LOAD GROUP (Continued)

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	Opcode 76 543 210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
LD IX, (nn)	IX _H ← (nn + 1) IX _L ← (nn)	•	•	X	•	X	•	11 011 101 00 101 010	DD 2A	4	6	20	
								← n → ← n →					
LD IY, (nn)	IY _H ← (nn + 1) IY _L ← (nn)	•	•	X	•	X	•	11 111 101 00 101 010	FD 2A	4	6	20	
								← n → ← n →					
LD (nn), HL	(nn + 1) ← H (nn) ← L	•	•	X	•	X	•	00 100 010	22	3	5	16	
								← n → ← n →					
LD (nn), dd	(nn + 1) ← dd _H (nn) ← dd _L	•	•	X	•	X	•	11 101 101 01 dd0 011	ED	4	6	20	
								← n → ← n →					
LD (nn), IX	(nn + 1) ← IX _H (nn) ← IX _L	•	•	X	•	X	•	11 011 101 00 100 010	DD 22	4	6	20	
								← n → ← n →					
LD (nn), IY	(nn + 1) ← IY _H (nn) ← IY _L	•	•	X	•	X	•	11 111 101 00 100 010	FD 22	4	6	20	
								← n → ← n →					
LD SP, HL	SP ← HL	•	•	X	•	X	•	11 111 001	F9	1	1	6	
LD SP, IX	SP ← IX	•	•	X	•	X	•	11 011 101 11 111 001	DD F9	2	2	10	
LD SP, IY	SP ← IY	•	•	X	•	X	•	11 111 101 11 111 001	FD F9	2	2	10	
PUSH qq	(SP - 2) ← qq _L (SP - 1) ← qq _H SP → SP - 2	•	•	X	•	X	•	11 qq0 101		1	3	11	qq Pair 00 BC 01 DE 10 HL 11 AF
PUSH IX	(SP - 2) ← IX _L (SP - 1) ← IX _H SP → SP - 2	•	•	X	•	X	•	11 011 101 11 100 101	DD E5	2	4	15	
PUSH IY	(SP - 2) ← IY _L (SP - 1) ← IY _H SP → SP - 2	•	•	X	•	X	•	11 111 101 11 100 101	FD E5	2	4	15	
POP qq	qq _H ← (SP + 1) qq _L ← (SP) SP → SP + 2	•	•	X	•	X	•	11 qq0 001		1	3	10	
POP IX	IX _H ← (SP + 1) IX _L ← (SP) SP → SP + 2	•	•	X	•	X	•	11 011 101 11 100 001	DD E1	2	4	14	
POP IY	IY _H ← (SP + 1) IY _L ← (SP) SP → SP + 2	•	•	X	•	X	•	11 111 101 11 100 001	FD E1	2	4	14	

NOTE: (PAIR)_H, (PAIR)_L refer to high order and low order eight bits of the register pair respectively, e.g., BC_L = C, AF_H = A.

EXCHANGE, BLOCK TRANSFER, BLOCK SEARCH GROUPS

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	Opcode 78 543 210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
EX DE, HL	DE $\leftrightarrow$ HL	•	•	X	•	X	•	11 101 011	EB	1	1	4	
EX AF, AF'	AF $\leftrightarrow$ AF'	•	•	X	•	X	•	00 001 000	08	1	1	4	
EXX	BC $\leftrightarrow$ BC' DE $\leftrightarrow$ DE' HL $\leftrightarrow$ HL'	•	•	X	•	X	•	11 011 001	D8	1	1	4	Register bank and auxiliary register bank exchange
EX (SP), HL	H $\leftrightarrow$ (SP + 1) L $\leftrightarrow$ (SP)	•	•	X	•	X	•	11 100 011	E3	1	5	19	
EX (SP), IX	IX _H $\leftrightarrow$ (SP + 1) IX _L $\leftrightarrow$ (SP)	•	•	X	•	X	•	11 011 101 11 100 011	DD E3	2	6	23	
EX (SP), IY	IY _H $\leftrightarrow$ (SP + 1) IY _L $\leftrightarrow$ (SP)	•	•	X	•	X	•	11 111 101 11 100 011	FD E3	2	6	23	
LDI	(DE) $\leftarrow$ (HL) DE $\leftarrow$ DE + 1 HL $\leftarrow$ HL + 1 BC $\leftarrow$ BC - 1	•	•	X	0	X	^① 1	11 101 101 10 100 000	ED A0	2	4	16	Load (HL) into (DE), increment the pointers and decrement the byte counter (BC)
LDIR	(DE) $\leftarrow$ (HL) DE $\leftarrow$ DE + 1 HL $\leftarrow$ HL + 1 BC $\leftarrow$ BC - 1 Repeat until BC = 0	•	•	X	0	X	^② 0	11 101 101 10 110 000	ED B0	2 2	5 4	21 16	If BC $\neq$ 0 If BC = 0
LDD	(DE) $\leftarrow$ (HL) DE $\leftarrow$ DE - 1 HL $\leftarrow$ HL - 1 BC $\leftarrow$ BC - 1	•	•	X	0	X	^① 1	11 101 101 10 101 000	ED A8	2	4	18	
LDDR	(DE) $\leftarrow$ (HL) DE $\leftarrow$ DE - 1 HL $\leftarrow$ HL - 1 BC $\leftarrow$ BC - 1 Repeat until BC = 0	•	•	X	0	X	^② 0	11 101 101 10 111 000	ED B8	2 2	5 4	21 16	If BC $\neq$ 0 If BC = 0
CPI	A - (HL) HL $\leftarrow$ HL + 1 BC $\leftarrow$ BC - 1	^③ 1	^③ 1	X	^① 1	X	^① 1	11 101 101 10 100 001	ED A1	2	4	16	

NOTE: ① P/V flag is 0 if the result of BC - 1 = 0, otherwise P/V = 1.
 ② P/V flag is 0 only at completion of instruction.
 ③ Z flag is 1 if A = HL, otherwise Z = 0.

EXCHANGE, BLOCK TRANSFER, BLOCK SEARCH GROUPS (Continued)

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	Opcode 75 543 210			Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments	
CPIR	A ← (HL)	③		X	①		1	*	11	101	101	ED	2	5	21	If BC ≠ 0 and A ≠ (HL)
	HL ← HL + 1								10	110	001	B1	2	4	16	If BC = 0 or A = (HL)
	BC ← BC - 1															
	Repeat until A = (HL) or BC = 0															
CPD	A ← (HL)	③		X	①		1	*	11	101	101	ED	2	4	16	
	HL ← HL - 1								10	101	001	A9				
	BC ← BC - 1															
CPDR	A ← (HL)	③		X	①		1	*	11	101	101	ED	2	5	21	If BC ≠ 0 and A ≠ (HL)
	HL ← HL - 1								10	111	001	B9	2	4	16	If BC = 0 or A = (HL)
	BC ← BC - 1															
	Repeat until A = (HL) or BC = 0															

NOTE: ① P/V flag is 0 if the result of BC - 1 = 0, otherwise P/V = 1.
 ② P/V flag is 0 only at completion of instruction.
 ③ Z flag is 1 if A = (HL), otherwise Z = 0.

8-BIT ARITHMETIC AND LOGICAL GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	75	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments	
ADD A, r	$A \leftarrow A + r$	†	†	X	†	X	V	0	†	10	000	r	1	1	4	r Reg.
ADD A, n	$A \leftarrow A + n$	†	†	X	†	X	V	0	†	11	000	← n →	2	2	7	000 B 001 C 010 D 011 E
ADD A, (HL)	$A \leftarrow A + (HL)$	†	†	X	†	X	V	0	†	10	000	110	1	2	7	100 H 101 L 111 A
ADD A, (IX+d)	$A \leftarrow A + (IX + d)$	†	†	X	†	X	V	0	†	11	011	101	DD	3	5	19
										10	000	← d →				
ADD A, (IY+d)	$A \leftarrow A + (IY + d)$	†	†	X	†	X	V	0	†	11	111	101	FD	3	5	19
										10	000	← d →				
ADC A, s	$A \leftarrow A + s + CY$	†	†	X	†	X	V	0	†		001					s is any of r, n, (HL), (IX + d), (IY + d) as shown for ADD instruction. The indicated bits replace the
SUB s	$A \leftarrow A - s$	†	†	X	†	X	V	1	†		010					
SBC A, s	$A \leftarrow A - s - CY$	†	†	X	†	X	V	1	†		011					
AND s	$A \leftarrow A \> s$	†	†	X	1	X	P	0	0		100					
OR s	$A \leftarrow A \> s$	†	†	X	0	X	P	0	0		110					
XOR s	$A \leftarrow A \oplus s$	†	†	X	0	X	P	0	0		101					
CP s	$A - s$	†	†	X	†	X	V	1	†		111					

8-BIT ARITHMETIC AND LOGICAL GROUP (Continued)

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	Opcode 76 543 210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
INC r	$r \leftarrow r + 1$	†	†	X	†	X	V 0 •	00 r 100		1	1	4	
INC (HL)	(HL) $\leftarrow$ (HL) + 1	†	†	X	†	X	V 0 •	00 110 100		1	3	11	
INC (IX + d)	(IX + d) $\leftarrow$ (IX + d) + 1	†	†	X	†	X	V 0 •	11 011 101 00 110 100	DD	3	6	23	
								$\leftarrow d \rightarrow$					
INC (IY + d)	(IY + d) $\leftarrow$ (IY + d) + 1	†	†	X	†	X	V 0 •	11 111 101 00 110 100	FD	3	6	23	
								$\leftarrow d \rightarrow$					
DEC m	$m \leftarrow m - 1$	†	†	X	†	X	V 1 •		101				

NOTE: m is any of r, (HL), (IX + d), (IY + d) as shown for INC. DEC same format and states as INC. Replace 100 with 101 in opcode.

GENERAL-PURPOSE ARITHMETIC AND CPU CONTROL GROUPS

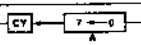
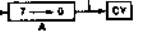
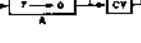
Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	Opcode 76 543 210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
DAA	@	†	†	X	†	X	P • †	00 100 111	27	1	1	4	Decimal adjust accumulator.
CPL	$A \leftarrow A$	•	•	X	1	X	• 1 •	00 101 111	2F	1	1	4	Complement accumulator (one's complement).
NEG	$A \leftarrow 0 - A$	†	†	X	†	X	V 1 †	11 101 101 01 000 100	ED 44	2	2	8	Negate acc. (two's complement).
CCF	$CY \leftarrow CY$	•	•	X	X	X	• 0 †	00 111 111	3F	1	1	4	Complement carry flag.
SCF	$CY \leftarrow 1$	•	•	X	0	X	• 0 1	00 110 111	37	1	1	4	Set carry flag.
NOP	No operation	•	•	X	•	X	• • •	00 000 000	00	1	1	4	
HALT	CPU halted	•	•	X	•	X	• • •	01 110 110	76	1	1	4	
DI ★	$IFF \leftarrow 0$	•	•	X	•	X	• • •	11 110 011	F3	1	1	4	
EI ★	$IFF \leftarrow 1$	•	•	X	•	X	• • •	11 111 011	FB	1	1	4	
IM 0	Set interrupt mode 0	•	•	X	•	X	• • •	11 101 101 01 000 110	ED 46	2	2	8	
IM 1	Set interrupt mode 1	•	•	X	•	X	• • •	11 101 101 01 010 110	ED 56	2	2	8	
IM 2	Set interrupt mode 2	•	•	X	•	X	• • •	11 101 101 01 011 110	ED 5E	2	2	8	

NOTES: @ converts accumulator content into packed BCD following add or subtract with packed BCD operands.
 IFF indicates the interrupt enable flip-flop.
 CY indicates the carry flip-flop.
 ★ indicates interrupts are not sampled at the end of EI or DI.

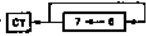
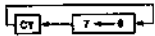
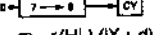
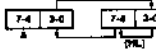
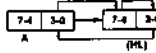
16-BIT ARITHMETIC GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	76	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
ADD HL, ss	HL ← HL + ss	•	•	X	X	X	•	0	†	00	ss1 001	1	3	11	ss Reg. 00 BC 01 DE 10 HL 11 SP
ADC HL, ss	HL ← HL + ss + CY	†	†	X	X	X	V	0	†	11 01 101 01	ss1 010	2	4	15	
SBC HL, ss	HL ← HL - ss - CY	†	†	X	X	X	V	1	†	11 01 101 01	ss0 010	2	4	15	
ADD IX, pp	IX ← IX + pp	•	•	X	X	X	•	0	†	11 01 101 01	pp1 001	2	4	15	pp Reg. 00 BC 01 DE 10 IX 11 SP
ADD IY, rr	IY ← IY + rr	•	•	X	X	X	•	0	†	11 00 101 00	rr1 001	2	4	15	rr Reg. 00 BC 01 DE 10 IY 11 SP
INC ss	ss ← ss + 1	•	•	X	•	X	•	•	•	00 ss0 011		1	1	6	
INC IX	IX ← IX + 1	•	•	X	•	X	•	•	•	11 00 100 011	23	2	2	10	
INC IY	IY ← IY + 1	•	•	X	•	X	•	•	•	11 00 100 011	23	2	2	10	
DEC ss	ss ← ss - 1	•	•	X	•	X	•	•	•	00 ss1 011		1	1	6	
DEC IX	IX ← IX - 1	•	•	X	•	X	•	•	•	11 00 101 011	2B	2	2	10	
DEC IY	IY ← IY - 1	•	•	X	•	X	•	•	•	11 00 101 011	2B	2	2	10	

ROTATE AND SHIFT GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H	P/V	N	C	76	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
RLCA		•	•	X	0	X	•	0	†	00 000 111	07	1	1	4	Rotate left circular accumulator.
RLA		•	•	X	0	X	•	0	†	00 010 111	17	1	1	4	Rotate left accumulator.
RRCA		•	•	X	0	X	•	0	†	00 001 111	0F	1	1	4	Rotate right circular accumulator.
RRA		•	•	X	0	X	•	0	†	00 011 111	1F	1	1	4	Rotate right accumulator.

ROTATE AND SHIFT GROUP (Continued)

Mnemonic	Symbolic Operation	S	Z	Flags				Opcode				Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
				H	P/V	N	C	76	543	210						
RLC r		†	†	X	0	X	P	0	*	†	11 001 011	CB	2	2	8	Rotate left circular register r.
								00	000	r						
RLC (HL)		†	†	X	0	X	P	0	†	11 001 011	CB	2	4	15		r Reg.
								00	000	110						000 B
																001 C
RLC (IX+d)		†	†	X	0	X	P	0	†	11 011 101	DD	4	6	23		010 D
	$r_i(HL), (IX+d), (IY+d)$							11	001 011	CB						011 E
									$\leftarrow d \rightarrow$							001 H
								00	000	110						101 L
																111 A
RLC (IY+d)		†	†	X	0	X	P	0	†	11 111 101	FD	4	6	23		
								11	001 011	CB						
									$\leftarrow d \rightarrow$							
								00	000	110						
RL m		†	†	X	0	X	P	0	†		001 010					
	$m = r_i(HL), (IX+d), (IY+d)$															
RRC m		†	†	X	0	X	P	0	†		001					
	$m = r_i(HL), (IX+d), (IY+d)$															
RR m		†	†	X	0	X	P	0	†		011					
	$m = r_i(HL), (IX+d), (IY+d)$															
SLA m		†	†	X	0	X	P	0	†		100					
	$m = r_i(HL), (IX+d), (IY+d)$															
SRA m		†	†	X	0	X	P	0	†		101					
	$m = r_i(HL), (IX+d), (IY+d)$															
SRL m		†	†	X	0	X	P	0	†		111					
	$m = r_i(HL), (IX+d), (IY+d)$															
RLD		†	†	X	0	X	P	0	*	11 101 101	ED	2	5	18	Rotate digit left and right between the accumulator and location (HL).	
								01	101 111	6F						
RRD		†	†	X	0	X	P	0	*	11 101 101	ED	2	5	18	The content of the upper half of the accumulator is unaffected.	
								01	100 111	67						

BIT SET, RESET AND TEST GROUP

Mnemonic	Symbolic Operation	S	Z	Flags	P/V	N	C	75	543	210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
BIT b, r	$Z \leftarrow r_b$	X	†	X	1	X	X	0	•	11 001 011	CB	2	2	8	r Reg. 000 B
										01 b r					
BIT b, (HL)	$Z \leftarrow (HL)_b$	X	†	X	1	X	X	0	•	11 001 011	CB	2	3	12	001 C 010 D
										01 b 110					
BIT b, (IX+d) _b	$Z \leftarrow (IX+d)_b$	X	†	X	1	X	X	0	•	11 011 101	DD	4	5	20	011 E 100 H
										11 001 011	CB				101 L 111 A
										← d →					b Bit Tested
										01 b 110					
BIT b, (IY+d) _b	$Z \leftarrow (IY+d)_b$	X	†	X	1	X	X	0	•	11 111 101	FD	4	5	20	000 0 001 1
										11 001 011	CB				010 2 011 3
										← d →					
										01 b 110					
SET b, r	$r_b \leftarrow 1$	•	•	X	•	X	•	•	•	11 001 011	CB	2	2	8	100 4 101 5
										11 b r					
SET b, (HL)	$(HL)_b \leftarrow 1$	•	•	X	•	X	•	•	•	11 001 011	CB	2	4	15	110 6 111 7
										11 b 110					
SET b, (IX+d)	$(IX+d)_b \leftarrow 1$	•	•	X	•	X	•	•	•	11 011 101	DD	4	6	23	
										11 001 011	CB				
										← d →					
										11 b 110					
SET b, (IY+d)	$(IY+d)_b \leftarrow 1$	•	•	X	•	X	•	•	•	11 111 101	FD	4	6	23	
										11 001 011	CB				
										← d →					
										11 b 110					
RES b, m	$m_b \leftarrow 0$ $m \leftarrow r, (HL),$ $(IX+d), (IY+d)$	•	•	X	•	X	•	•	•	11 101 101					
										10 b 110					

To form new opcode replace **11** of SET b, s with **10**. Flags and time states for SET instruction.

NOTE: The notation m_b indicates location m, bit b (0 to 7).

JUMP GROUP

Mnemonic	Symbolic Operation	S		Z		Flags			Opcode				Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
		S	Z	H	P/V/N	C	78	543	210								
JP nn	PC ← nn	•	•	X	•	X	•	•	•	11	000	011	C3	3	3	10	cc Condition 000 NZ (non-zero) 001 Z (zero) 010 NC (non-carry) 011 C (carry) 100 PO (parity odd) 101 PE (parity even) 110 P (sign positive) 111 M (sign negative)
JP cc, nn	If condition cc is true PC←nn, otherwise continue	•	•	X	•	X	•	•	•	11	cc	010		3	3	10	
JR e	PC ← PC + e	•	•	X	•	X	•	•	•	00	011	000	18	2	3	12	← e - 2 → If condition not met.
JR C, e	If C = 0, continue If C = 1, PC ← PC + e	•	•	X	•	X	•	•	•	00	111	000	38	2	2	7	
														2	3	12	If condition is met.
JR NC, e	If C = 1, continue If C = 0, PC ← PC + e	•	•	X	•	X	•	•	•	00	110	000	30	2	2	7	If condition not met.
														2	3	12	If condition is met.
JP Z, e	If Z = 0, continue If Z = 1, PC ← PC + e	•	•	X	•	X	•	•	•	00	101	000	28	2	2	7	If condition not met.
														2	3	12	If condition is met.
JR NZ, e	If Z = 1, continue If Z = 0, PC ← PC + e	•	•	X	•	X	•	•	•	00	100	000	20	2	2	7	If condition not met.
														2	3	12	If condition is met.
JP (HL)	PC ← HL	•	•	X	•	X	•	•	•	11	101	001	E9	1	1	4	
JP (IX)	PC ← IX	•	•	X	•	X	•	•	•	11	011	101	DD	2	2	8	
JP (IY)	PC ← IY	•	•	X	•	X	•	•	•	11	111	101	FD	2	2	8	
DJNZ, e	B ← B - 1 If B = 0, continue If B ≠ 0, PC ← PC + e	•	•	X	•	X	•	•	•	00	010	000	10	2	2	8	If B = 0
														2	3	13	If B ≠ 0.

NOTES: e represents the extension in the relative addressing mode.
e is a signed two's complement number in the range < -126, 129 >.
e - 2 in the opcode provides an effective address of pc + e as PC is incremented by 2 prior to the addition of e.

CALL AND RETURN GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H	P/VN	C	Opcode 76 543 210			Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments	
CALL nn	(SP-1)←PC _H (SP-2)←PC _L PC←nn, ←n→ ←n→	•	•	X	•	X	•	•	•	11 001 101 CD	3	5	17		
CALL cc,nn	If condition cc is false continue, otherwise same as CALL nn	•	•	X	•	X	•	•	•	11 cc 100	3	3	10	If cc is false.	
										←n→					
										←n→	3	5	17	If cc is true.	
RET	PC _L ←(SP) PC _H ←(SP+1)	•	•	X	•	X	•	•	•	11 001 001 C9	1	3	10		
RET cc	If condition cc is false continue, otherwise same as RET	•	•	X	•	X	•	•	•	11 cc 000	1	1	5	If cc is false.	
											1	3	11	If cc is true.	
															cc Condition
															000 NZ (non-zero)
															001 Z (zero)
															010 NC (non-carry)
RETI	Return from interrupt	•	•	X	•	X	•	•	•	11 101 101 ED	2	4	14	011 C (carry)	
										01 001 101 4D					100 PO (parity odd)
RETNI	Return from non-maskable interrupt	•	•	X	•	X	•	•	•	11 101 101 ED	2	4	14	101 PE (parity even)	
										01 000 101 45					110 P (sign positive)
															111 M (sign negative)
RST p	(SP-1)←PC _H (SP-2)←PC _L PC _H ←0 PC _L ←p	•	•	X	•	X	•	•	•	11 t 111	1	3	11	t p	
															000 00H
															001 08H
															010 10H
															011 18H
															100 20H
															101 28H
															110 30H
															111 38H

NOTE: 1 RETN loads IFF₂ → IFF₁

INPUT AND OUTPUT GROUP

Mnemonic	Symbolic Operation	S	Z	Flags H P/VN C	Opcode 76 543 210	Hex	No. of Bytes	No. of M Cycles	No. of T States	Comments
IN A, (n)	A ← (n)	•	•	X • X • • •	11 011 01	DB	2	3	11	n to A ₀ ~ A ₇ Acc. to A ₈ ~ A ₁₅
IN r, (C)	r ← (C) if r = 110 only the flags will be affected	•	•	X • X P 0 •	11 101 101 01 r 000	ED	2	3	12	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
INI	(HL) ← (C) B ← B - 1 HL ← HL + 1	①	X	• X X X X 1 X	11 101 101 10 100 010	ED A2	2	4	16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
INIR	(HL) ← (C) B ← B - 1 HL ← HL + 1 Repeat until B = 0	②	X	1 X X X X 1 X	11 101 101 10 110 010	ED B2	2	5 (If B ≠ 0) 4 (If B = 0)	21 16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
IND	(HL) ← (C) B ← B - 1 HL ← HL - 1	①	X	• X X X X 1 X	11 101 101 10 101 010	ED AA	2	4	16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
INDR	(HL) ← (C) B ← B - 1 HL ← HL - 1 Repeat until B = 0	②	X	1 X X X X 1 X	11 101 101 10 111 010	ED BA	2	5 (If B ≠ 0) 4 (If B = 0)	21 16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
OUT (n), A	(n) ← A	•	•	X • X • • •	11 010 011	D3	2	3	11	n to A ₀ ~ A ₇ Acc. to A ₈ ~ A ₁₅
OUT (C), r	(C) ← r	•	•	X • X • • •	11 101 101 01 r 001	ED	2	3	12	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
OUTI	(C) ← (HL) B ← B - 1 HL ← HL + 1	①	X	• X X X X 1 X	11 101 101 10 100 011	ED A3	2	4	16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
OTIR	(C) ← (HL) B ← B - 1 HL ← HL + 1 Repeat until B = 0	②	X	1 X X X X 1 X	11 101 101 10 110 011	ED B3	2	5 (If B ≠ 0) 4 (If B = 0)	21 16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
OUTD	(C) ← (HL) B ← B - 1 HL ← HL - 1	①	X	• X X X X 1 X	11 101 101 10 101 011	ED AB	2	4	16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅
OTDR	(C) ← (HL) B ← B - 1 HL ← HL - 1 Repeat until B = 0	②	X	1 X X X X 1 X	11 101 101 10 111 011	ED	2	5 (If B ≠ 0) 4 (If B = 0)	21 16	C to A ₀ ~ A ₇ B to A ₈ ~ A ₁₅

NOTES: ① If the result of B - 1 is zero, the Z flag is set; otherwise it is reset.
② Z flag is set upon instruction completion only.

SUMMARY OF FLAG OPERATION

Instructions	D ₇ S	Z	H	P/V	N	D ₀ C	Comments
ADD A, s; ADC A, s	†	†	X	†	X	0	8-bit add or add with carry.
SUB s; SBC A, s; CP s; NEG	†	†	X	†	X	1	8-bit subtract, subtract with carry, compare and negate accumulator.
AND s	†	†	X	1	X	0	Logical operation.
OR s; XOR s	†	†	X	0	X	0	Logical operation.
INC s	†	†	X	†	X	0	8-bit increment.
DEC s	†	†	X	†	X	1	8-bit decrement.
ADD DD, ss	•	•	X	X	X	0	16-bit add.
ADC HL, ss	†	†	X	X	X	0	16-bit add with carry.
SBC HL, ss	†	†	X	X	X	1	16-bit subtract with carry.
RLA; RLCA; RRA; RRCA	•	•	X	0	X	•	Rotate accumulator.
RL m; RLC m; RR m;	†	†	X	0	X	0	Rotate and shift locations.
RRC m; SLA m;							
SRA m; SRL m							
RLD; RRD	†	†	X	0	X	0	Rotate digit left and right.
DAA	†	†	X	†	X	•	Decimal adjust accumulator.
CPL	•	•	X	1	X	•	Complement accumulator.
SCF	•	•	X	0	X	•	Set carry.
CCF	•	•	X	X	X	•	Complement carry.
IN r(C)	†	†	X	0	X	0	Input register indirect.
INI; IND; OUTI; OUTD	X	†	X	X	X	1	Block input and output. Z = 1 if B ≠ 0, otherwise Z = 0.
INIR; INDR; OTIR; OTDR	X	1	X	X	X	1	Block input and output. Z = 1 if B ≠ 0, otherwise Z = 0.
LDI; LDD	X	X	X	0	X	†	Block transfer instructions. P/V = 1 if BC ≠ 0, otherwise P/V = 0.
LDIR; LDDR	X	X	X	0	X	0	Block transfer instructions. P/V = 1 if BC ≠ 0, otherwise P/V = 0.
CPI; CPIR; CPD; CPDR	X	†	X	X	X	†	Block search instructions. Z = 1 if A = (HL), otherwise Z = 0. P/V = 1 if BC ≠ 0, otherwise P/V = 0.
LDA; L, LDA, R	†	†	X	0	X	IFF	IFF, the content of the interrupt enable flip-flop, (IFF ₂), is copied into the P/V flag.
BIT b, s	X	†	X	1	X	0	The state of bit b of location s is copied into the Z flag.

SYMBOLIC NOTATION

Symbol	Operation	Symbol	Operation
S	Sign flag. S = 1 if the MSB of the result is 1.	†	The flag is affected according to the result of the operation.
Z	Zero flag. Z = 1 if the result of the operation is 0.	•	The flag is unchanged by the operation.
P/V	Parity or overflow flag. Parity (P) and overflow (V) share the same flag. Logical operations affect this flag with the parity of the result while arithmetic operations affect this flag with the overflow of the result. If P/V holds parity: P/V = 1 if the result of the operation is even; P/V = 0 if result is odd. If P/V holds overflow, P/V = 1 if the result of the operation produced an overflow. If P/V does not hold overflow, P/V = 0.	0	The flag is reset by the operation.
H*	Half-carry flag. H = 1 if the add or subtract operation produced a carry into, or borrow from, bit 4 of the accumulator.	1	The flag is set by the operation.
N*	Add/Subtract flag. N = 1 if the previous operation was a subtract.	X	The flag is indeterminate.
C	Carry/Link flag. C = 1 if the operation produced a carry from the MSB of the operand or result.	V	P/V flag affected according to the overflow result of the operation.
		P	P/V flag affected according to the parity result of the operation.
		r	Any one of the CPU registers A, B, C, D, E, H, L.
		s	Any 8-bit location for all the addressing modes allowed for the particular instruction.
		ss	Any 16-bit location for all the addressing modes allowed for that instruction.
		ii	Any one of the two index registers IX or IY.
		R	Refresh counter.
		n	8-bit value in range < 0, 255 >.
		nn	16-bit value in range < 0, 65535 >.

* H and N flags are used in conjunction with the decimal adjust instruction (DAA) to properly correct the result into packed BCD format following addition or subtraction using operands with packed BCD format.

CPU REGISTERS

Figure 4 shows three groups of registers within the CPU. The first group consists of duplicate sets of 8-bit registers: a principal set and an alternate set [designated by ' (prime), e.g., A']. Both sets consist of the Accumulator register, the Flag register, and six general-purpose registers. Transfer of data between these duplicate sets of registers is accomplished by use of "Exchange" instructions. The result is faster response to interrupts and easy, efficient implementation of such versatile programming techniques

as background-foreground data processing. The second set of registers consists of six registers with assigned functions. These are the I (Interrupt register), the R (Refresh register), the IX and IY (Index registers), the SP (Stack Pointer), and the PC (Program Counter). The third group consists of two interrupt status flip-flops, plus an additional pair of flip-flops which assists in identifying the interrupt mode at any particular time. Table 1 provides further information on these registers.

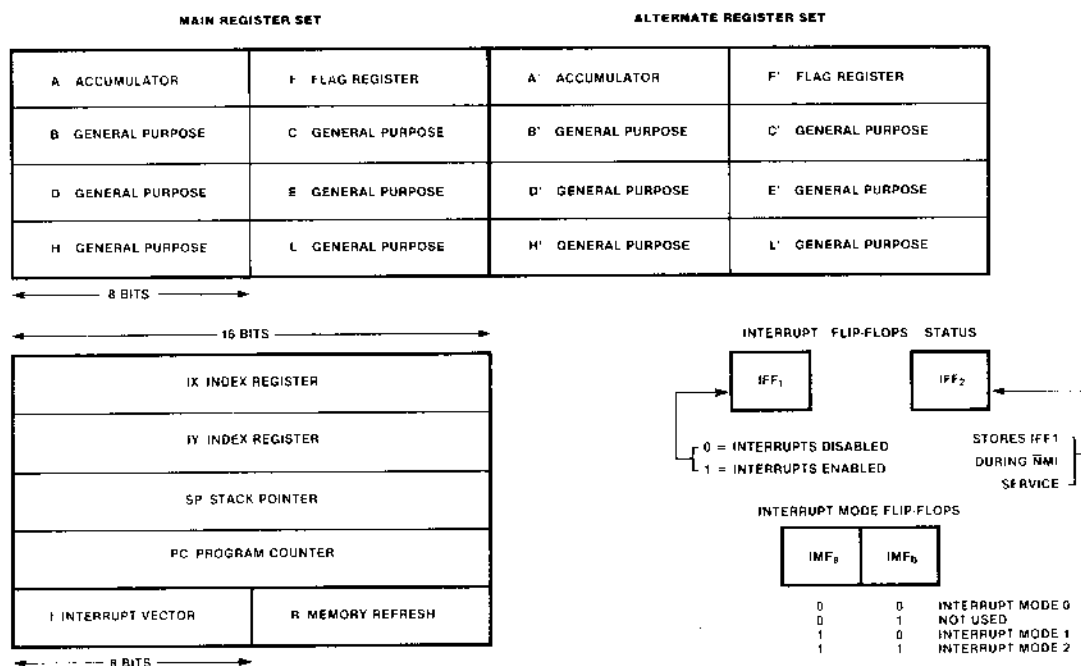


Figure 4. CPU Registers

INTERRUPTS: GENERAL OPERATION

The CPU accepts two interrupt input signals: $\overline{\text{NMI}}$ and $\overline{\text{INT}}$. The $\overline{\text{NMI}}$ is a non-maskable interrupt and has the highest priority. $\overline{\text{INT}}$ is a lower priority interrupt and it requires that interrupts be enabled in software in order to operate. $\overline{\text{INT}}$ can be connected to multiple peripheral devices in a wired-OR configuration.

The Z80 has a single response mode for interrupt service on the non-maskable interrupt. The maskable interrupt, $\overline{\text{INT}}$, has three programmable response modes available. These are:

- Mode 0 — similar to the 8080 microprocessor.
- Mode 1 — Peripheral Interrupt service, for use with non-8080/Z80 systems.

- Mode 2 — a vectored interrupt scheme, usually daisy-chained, for use with the Z80 Family and compatible peripheral devices.

The CPU services interrupts by sampling the $\overline{\text{NMI}}$ and $\overline{\text{INT}}$ signals at the rising edge of the last clock of an instruction. Further interrupt service processing depends upon the type of interrupt that was detected. Details on interrupt responses are shown in the CPU Timing Section.

Non-Maskable Interrupt ($\overline{\text{NMI}}$). The nonmaskable interrupt cannot be disabled by program control and therefore will be accepted at all times by the CPU. $\overline{\text{NMI}}$ is usually reserved for servicing only the highest priority type interrupts, such as that for orderly shutdown after power

PIN DESCRIPTIONS

A₀-A₁₅. *Address Bus* (output, active High, 3-state). A₀-A₁₅ form a 16-bit address bus. The Address Bus provides the address for memory data bus exchanges (up to 64K bytes) and for I/O device exchanges.

BUSACK. *Bus Acknowledge* (output, active Low). Bus Acknowledge indicates to the requesting device that the CPU address bus, data bus, and control signals MREQ, IORQ, RD, and WR have entered their high-impedance states. The external circuitry can now control these lines.

BUSREQ. *Bus Request* (input, active Low). Bus Request has a higher priority than NMI and is always recognized at the end of the current machine cycle. BUSREQ forces the CPU address bus, data bus, and control signals MREQ, IORQ, RD, and WR to go to a high-impedance state so that other devices can control these lines. BUSREQ is normally wired-OR and requires an external pullup for these applications. Extended BUSREQ periods due to extensive DMA operations can prevent the CPU from properly refreshing dynamic RAMs.

D₀-D₇. *Data Bus* (input/output, active High, 3-state). D₀-D₇ constitute an 8-bit bidirectional data bus, used for data exchanges with memory and I/O.

HALT. *Halt State* (output, active Low). HALT indicates that the CPU has executed a Halt instruction and is awaiting either a nonmaskable or a maskable interrupt (with the mask enabled) before operation can resume. While halted, the CPU executes NOPs to maintain memory refresh.

INT. *Interrupt Request* (input, active Low). Interrupt Request is generated by I/O devices. The CPU honors a request at the end of the current instruction if the internal software-controlled interrupt enable flip-flop (IFF) is enabled. INT is normally wired-OR and requires an external pullup for these applications.

IORQ. *Input/Output Request* (output, active Low, 3-state). IORQ indicates that the lower half of the address bus holds a valid I/O address for an I/O read or write operation. IORQ is also generated concurrently with M1 during an interrupt acknowledge cycle to indicate that an interrupt response vector can be placed on the data bus.

M1. *Machine Cycle One* (output, active Low). M1, together with MREQ, indicates that the current machine cycle is the opcode fetch cycle of an instruction execution. M1, together with IORQ, indicates an interrupt acknowledge cycle.

MREQ. *Memory Request* (output, active Low, 3-state). MREQ indicates that the address bus holds a valid address for a memory read or memory write operation.

NMI. *Non-Maskable Interrupt* (input, negative edge-triggered). NMI has a higher priority than INT. NMI is always recognized at the end of the current instruction, independent of the status of the interrupt enable flip-flop, and automatically forces the CPU to restart at location 0066H.

RD. *Read* (output, active Low, 3-state). RD indicates that the CPU wants to read data from memory or an I/O device. The addressed I/O device or memory should use this signal to gate data onto the CPU data bus.

RESET. *Reset* (input, active Low). RESET initializes the CPU as follows: it resets the interrupt enable flip-flop, clears the PC and Registers I and R, and sets the interrupt status to Mode 0. During reset time, the address and data bus go to a high-impedance state, and all control output signals go to the inactive state. Note that RESET must be active for a minimum of three full clock cycles before the reset operation is complete.

RFSH. *Refresh* (output, active Low). RFSH, together with MREQ, indicates that the lower seven bits of the system's address bus can be used as a refresh address to the system's dynamic memories.

WAIT. *Wait* (input, active Low). WAIT indicates to the CPU that the addressed memory or I/O devices are not ready for a data transfer. The CPU continues to enter a Wait state as long as this signal is active. Extended WAIT periods can prevent the CPU from properly refreshing dynamic memory.

WR. *Write* (output, active Low, 3-state). WR indicates that the CPU data bus holds valid data to be stored at the addressed memory or I/O location.

CPU TIMING

The Z80 CPU executes instructions by proceeding through a specific sequence of operations:

- Memory read or write
- I/O device read or write
- Interrupt acknowledge

The basic clock period is referred to as a T time or cycle, and three or more T cycles make up a machine cycle (M1, M2 or M3 for instance). Machine cycles can be extended either by the CPU automatically inserting one or more Wait states or by the insertion of one or more Wait states by the user.

Instruction Opcode Fetch. The CPU places the contents of the Program Counter (PC) on the address bus at the start of the cycle (Figure 5). Approximately one-half clock cycle later, $\overline{MREQ}$ goes active. When active, $\overline{RD}$ indicates that the memory data can be enabled onto the CPU data bus.

The CPU samples the $\overline{WAIT}$ input with the falling edge of clock state T_2 . During clock states T_3 and T_4 of an M1 cycle, dynamic RAM refresh can occur while the CPU starts decoding and executing the instruction. When the Refresh Control signal becomes active, refreshing of dynamic memory can take place.

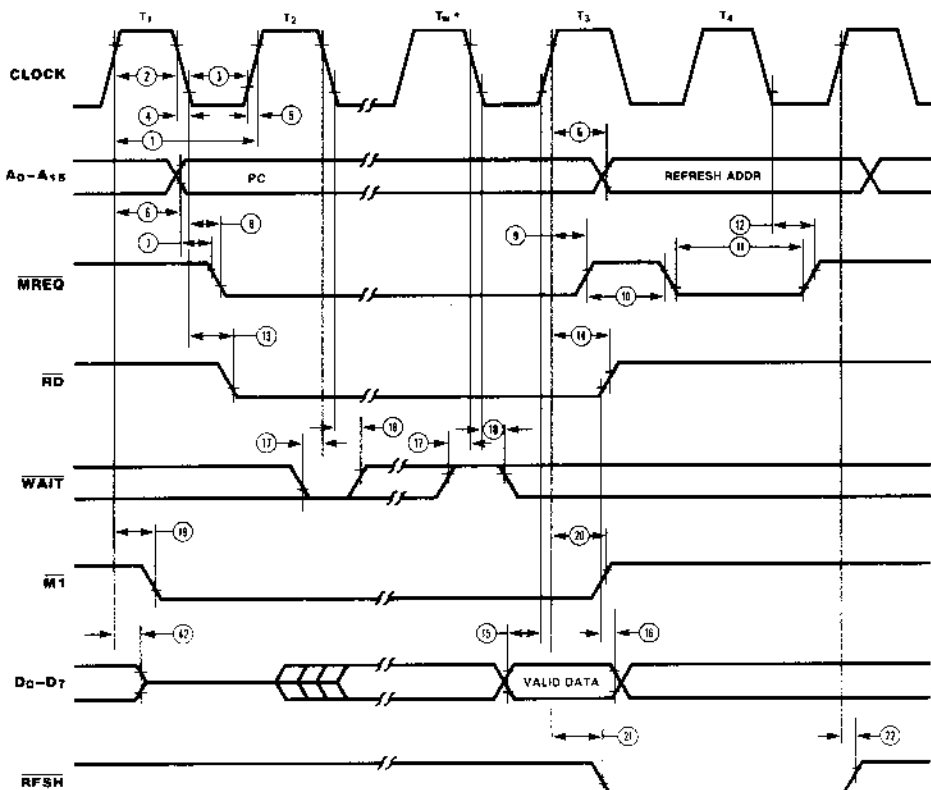


Figure 5. Instruction Opcode Fetch

Memory Read or Write Cycles. Figure 6 shows the timing of memory read or write cycles other than an opcode fetch (M1) cycle. The $\overline{\text{MREQ}}$ and $\overline{\text{RD}}$ signals function exactly as in the fetch cycle. In a memory write cycle, $\overline{\text{MREQ}}$ also

becomes active when the address bus is stable. The $\overline{\text{WR}}$ line is active when the data bus is stable, so that it can be used directly as an $\text{R}/\overline{\text{W}}$ pulse to most semiconductor memories.

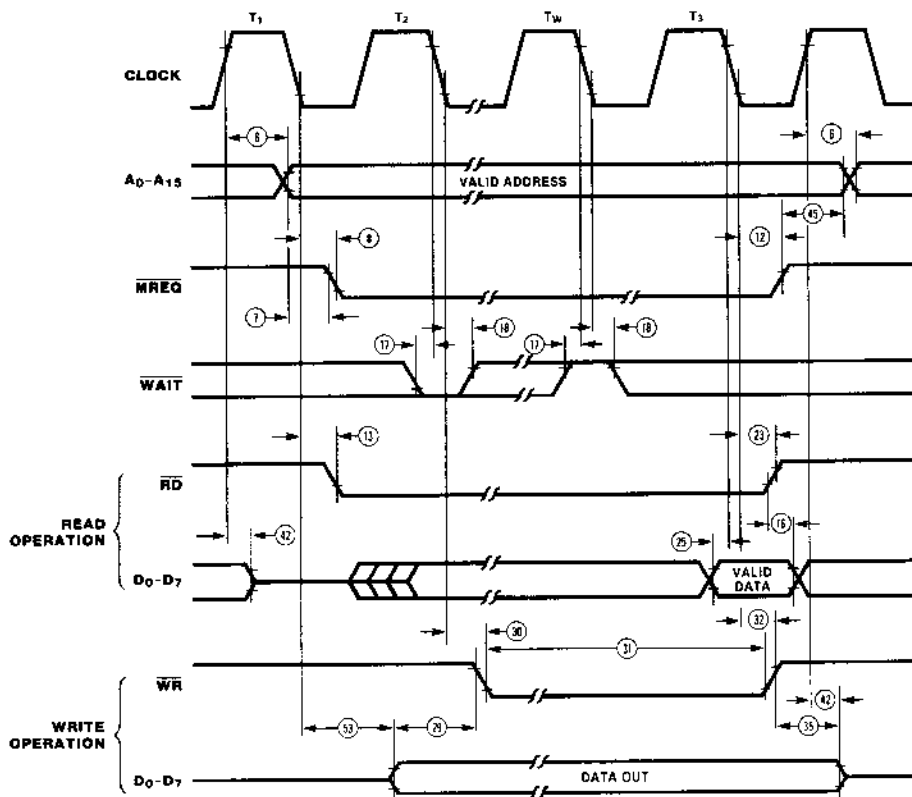
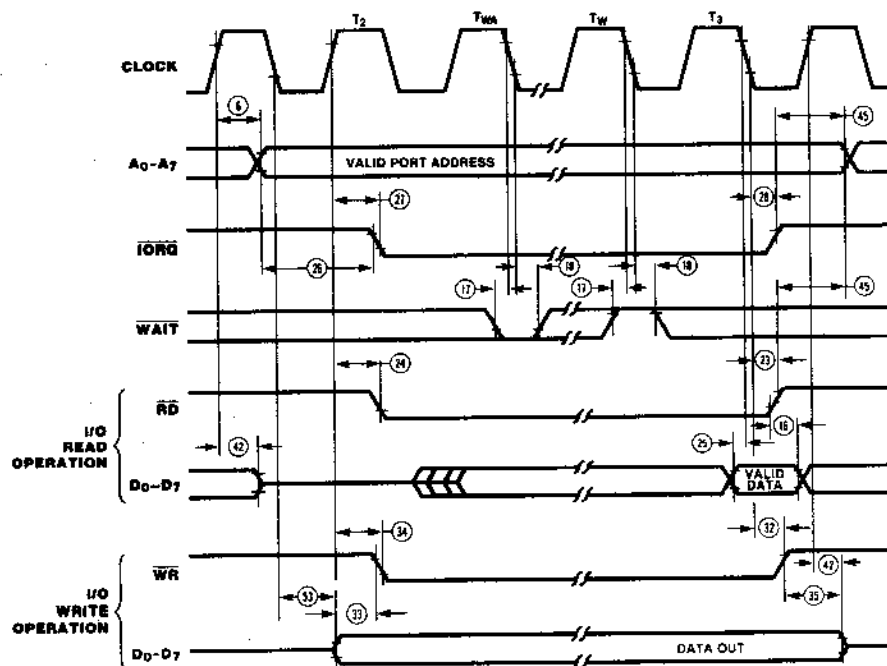


Figure 6. Memory Read or Write Cycles

Input or Output Cycles. Figure 7 shows the timing for an I/O read or I/O write operation. During I/O operations, the CPU automatically inserts a single Wait state (T_{WA}). This

extra Wait state allows sufficient time for an I/O port to decode the address from the port address lines.

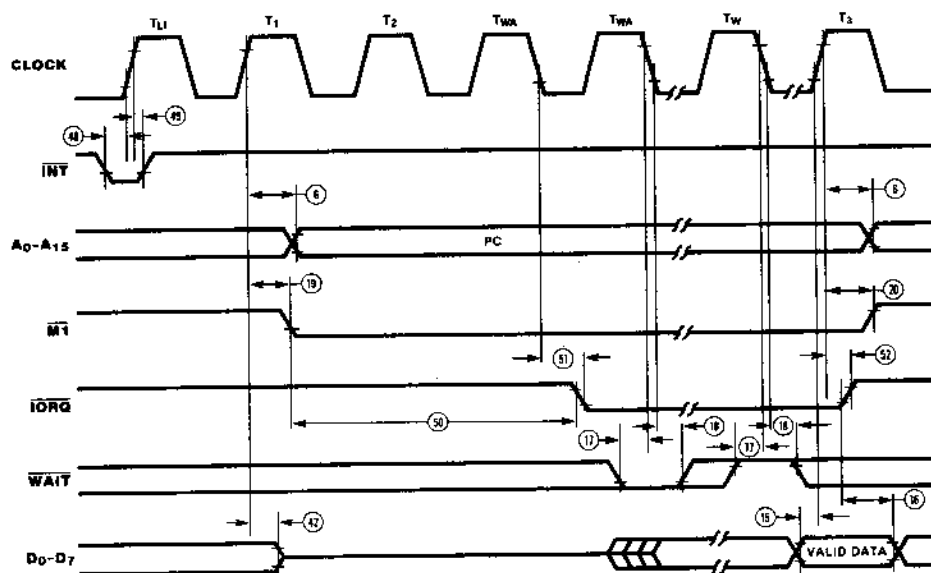


T_{WA} = One wait cycle automatically inserted by CPU.

Figure 7. Input or Output Cycles

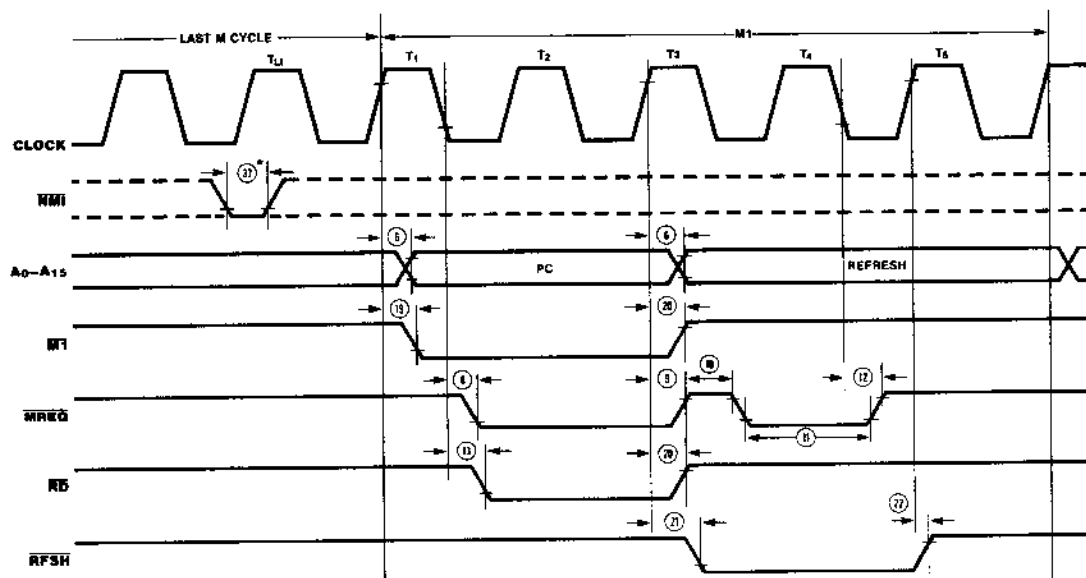
Interrupt Request/Acknowledge Cycle. The CPU samples the interrupt signal with the rising edge of the last clock cycle at the end of any instruction (Figure 8). When an interrupt is accepted, a special M1 cycle is generated.

During this M1 cycle, $\overline{\text{IORQ}}$ becomes active (instead of $\overline{\text{MREQ}}$) to indicate that the interrupting device can place an 8-bit vector on the data bus. The CPU automatically adds two Wait states to this cycle.



Non-Maskable Interrupt Request Cycle. $\overline{\text{NMI}}$ is sampled at the same time as the maskable interrupt input $\overline{\text{INT}}$ but has higher priority and cannot be disabled under software control. The subsequent timing is similar to that of a normal

memory read operation except that data put on the bus by the memory is ignored. The CPU instead executes a restart (RST) operation and jumps to the $\overline{\text{NMI}}$ service routine located at address 0066H (Figure 9).

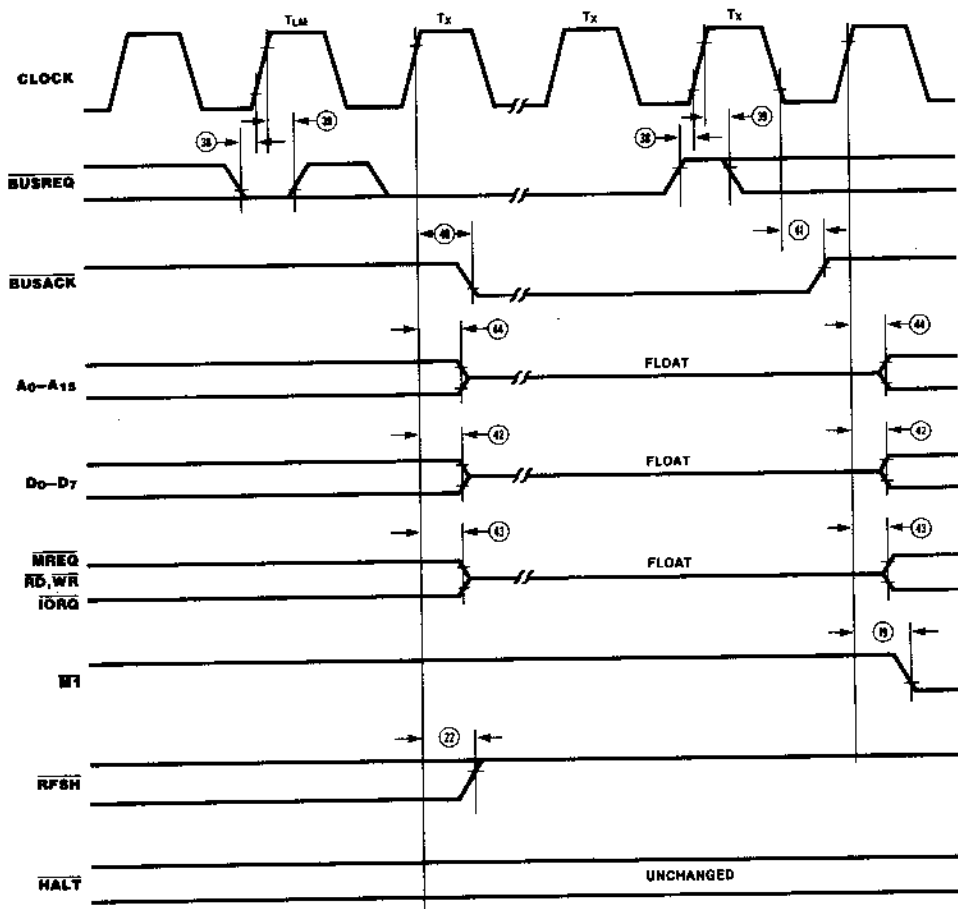


*Although $\overline{\text{NMI}}$ is an asynchronous input, to guarantee its being recognized on the following machine cycle, $\overline{\text{NMI}}$'s falling edge must occur no later than the rising edge of the clock cycle preceding the last state of any instruction cycle (T_0).

Figure 9. Non-Maskable Interrupt Request Operation

Bus Request/Acknowledge Cycle. The CPU samples BUSREQ with the rising edge of the last clock period of any machine cycle (Figure 10). If BUSREQ is active, the CPU sets its address, data, and MREQ, IORQ, RD, and WR lines

to a high-impedance state with the rising edge of the next clock pulse. At that time, any external device can take control of these lines, usually to transfer data between memory and I/O devices.

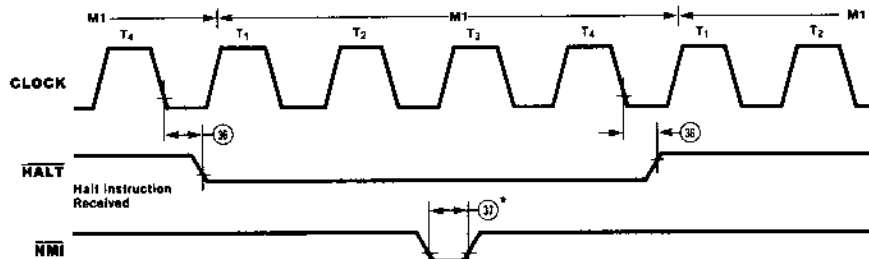


- NOTES: 1) T_{LM} = Last state of any M Cycle.
2) T_x = An arbitrary clock cycle used by requesting device.

Figure 10. BUS Request/Acknowledge Cycle

Halt Acknowledge Cycle. When the CPU receives a $\overline{\text{HALT}}$ instruction, it executes NOP states until either an $\overline{\text{INT}}$ or $\overline{\text{NMI}}$ input is received. When in the Halt state, the $\overline{\text{HALT}}$ output is

active and remains so until an interrupt is received (Figure 11). $\overline{\text{INT}}$ will also force a Halt exit.



*Although $\overline{\text{NMI}}$ is an asynchronous input, to guarantee its being recognized on the following machine cycle, $\overline{\text{NMI}}$'s falling edge must occur no later than the rising edge of the clock cycle preceding the last state of any instruction cycle (T_{L1}).

Figure 11. Halt Acknowledge

Reset Cycle. $\overline{\text{RESET}}$ must be active for at least three clock cycles for the CPU to properly accept it. As long as $\overline{\text{RESET}}$ remains active, the address and data buses float, and the control outputs are inactive. Once $\overline{\text{RESET}}$ goes inactive, two

internal T cycles are consumed before the CPU resumes normal processing operation. $\overline{\text{RESET}}$ clears the PC register, so the first opcode fetch will be to location 0000H (Figure 12).

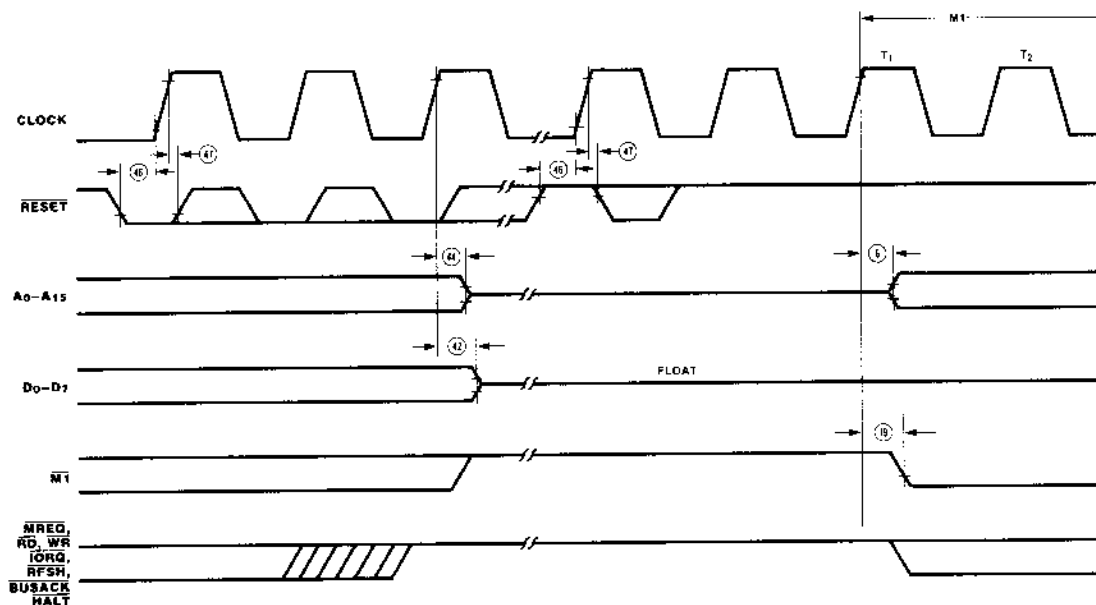


Figure 12. Reset Cycle

Power-Down mode of operation (Only applies to CMOS Z80 CPU).

CMOS Z80 CPU supports Power-Down mode of operation.

This mode is also referred to as the "standby mode", and supply current for the CPU goes down as low as 10 μA (Where specified as I_{CC2}).

Power-Down Acknowledge Cycle. When the clock input to the CPU is stopped at either a High or Low level, the CPU stops its operation and maintains all registers and control signals. However, I_{CC2} (standby supply current) is guaranteed only when the system clock is stopped at a Low

level during T_4 of the machine cycle following the execution of the HALT instruction. The timing diagram for the power-down function, when implemented with the HALT instruction, is shown in Figure 13.

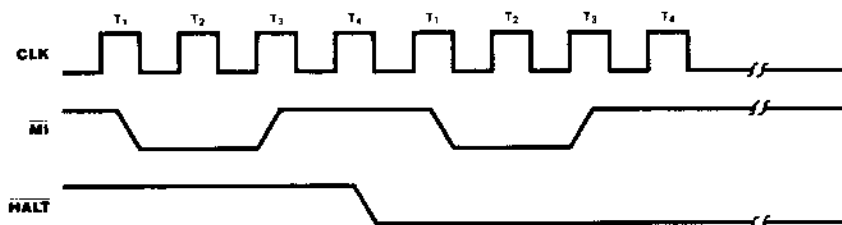


Figure 13. Power-Down Acknowledge

Power-Down Release Cycle. The system clock must be supplied to the CPU to release the power-down state. When the system clock is supplied to the CLK input, the CPU restarts operations from the point at which the power-down state was implemented. The timing diagrams for the release from power-down mode are shown in Figure 14.

NOTES:

- 1) When the external oscillator has been stopped to enter the power-down state, some warm-up time may be required to obtain a stable clock for the release.
- 2) When the HALT instruction is executed to enter the power-down state, the CPU will also enter the Halt state. An interrupt signal (either NMI or INT) or a RESET signal must be applied to the CPU after the system clock is supplied in order to release the power-down state.

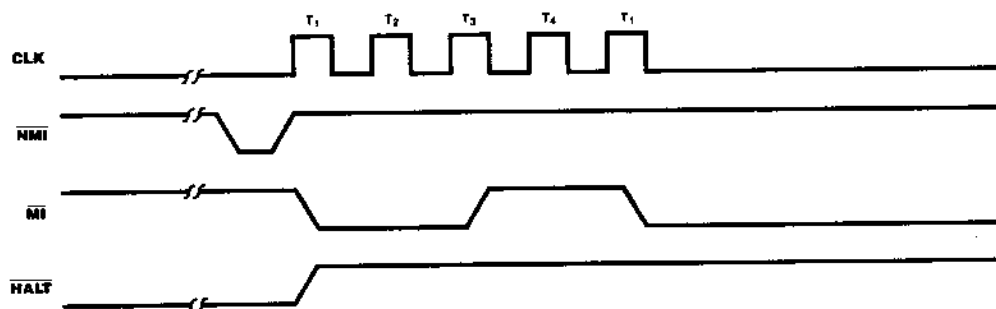


Figure 14a.

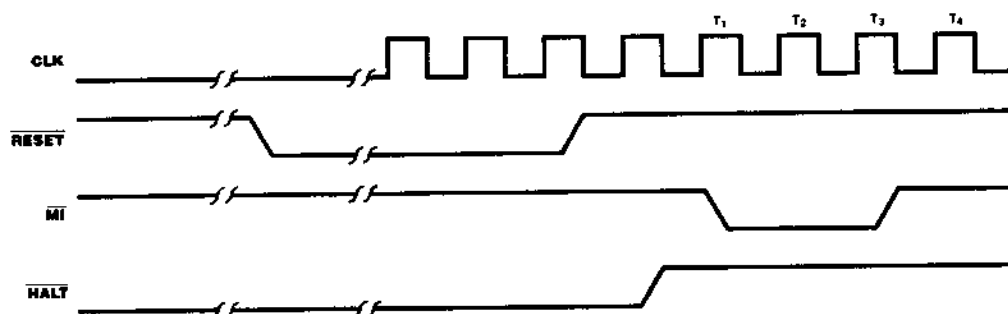


Figure 14b.

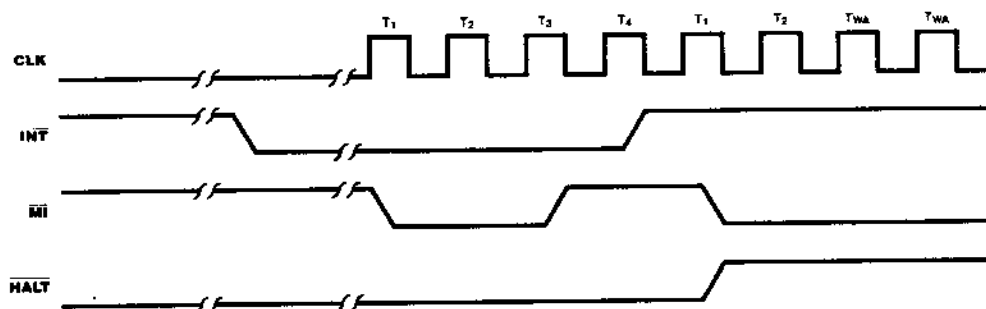


Figure 14c.

Figure 13. Power-Down Release

ABSOLUTE MAXIMUM RATINGS

Voltage on V_{CC} with respect to V_{SS}	-0.3V to +7V
Voltages on all inputs with respect to V_{SS}	-0.3V to $V_{CC} + 0.3V$
Operating Ambient Temperature	See Ordering Information
Storage Temperature	-65°C to +150°C

Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

STANDARD TEST CONDITIONS

The DC Characteristics and capacitance sections below apply for the following standard test conditions, unless otherwise noted. All voltages are referenced to GND (0V). Positive current flows into the referenced pin.

Available operating temperature ranges are:

■ S = 0°C to +70°C

Voltage Supply Range:

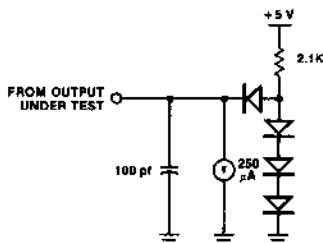
NMOS: $+4.75V \leq V_{CC} \leq +5.25V$

CMOS: $+4.50V \leq V_{CC} \leq +5.50V$

■ E = -40°C to 100°C, $+4.50V \leq V_{CC} \leq +5.50V$

All ac parameters assume a load capacitance of 100 pf. Add 10 ns delay for each 50 pf increase in load up to a maximum of 200 pf for the data bus and 100 pf for address and control lines. AC timing measurements are referenced to 1.5 volts (except for clock, which is referenced to the 10% and 90% points).

The Ordering Information section lists temperature ranges and product numbers. Package drawings are in the Package Information section. Refer to the Literature List for additional documentation.



DC CHARACTERISTICS (Z84C00/CMOS Z80 CPU)

Symbol	Parameter	Min	Max	Unit	Condition
V_{ILC}	Clock Input Low Voltage	-0.3	0.45	V	
V_{IHC}	Clock Input High Voltage	$V_{CC} - .6$	$V_{CC} + .3$	V	
V_{IL}	Input Low Voltage	-0.3	0.8	V	
V_{IH}	Input High Voltage	2.2	V_{CC}	V	
V_{OL}	Output Low Voltage		0.4	V	$I_{OL} = 2.0 \text{ mA}$
V_{OH1}	Output High Voltage	2.4		V	$I_{OH} = -1.6 \text{ mA}$
V_{OH2}	Output High Voltage	$V_{CC} - 0.8$		V	$I_{OH} = -250 \mu\text{A}$
I_{CC1}	Power Supply Current	4 MHz	20	mA	$V_{CC} = 5\text{V}$
			30	mA	$V_{IH} = V_{CC} - 0.2\text{V}$
			40	mA	$V_{IL} = 0.2\text{V}$
			50	mA	$V_{CC} = 5\text{V}$
			100	mA	$V_{CC} = 5\text{V}$
I_{CC2}	Standby Supply Current	20 MHz	10	μA	$\text{CLK} = (0)$
					$V_{IH} = V_{CC} - 0.2\text{V}$
					$V_{IL} = 0.2\text{V}$
I_{LI}	Input Leakage Current	-10	10	μA	$V_{IN} = 0.4 \text{ to } V_{CC}$
I_{LO}	3-State Output Leakage Current in Float	-10	10^2	μA	$V_{OUT} = 0.4 \text{ to } V_{CC}$

1. Measurements made with outputs floating.

2. A_{15} - A_0 , D_7 - D_0 , $MREQ$, $IORQ$, RD , and WR .

3. I_{CC2} standby supply current is guaranteed only when the supplied clock is stopped at a low level during T_4 of the machine cycle immediately following the execution of a HALT instruction.

CAPACITANCE

Symbol	Parameter	Min	Max	Unit
C_{CLOCK}	Clock Capacitance		10	pf
C_{IN}	Input Capacitance		5	pf
C_{OUT}	Output Capacitance		15	pf

$T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$.

Unmeasured pins returned to ground.

AC CHARACTERISTICS† (Z84C00/CMOS Z80 CPU)

V_{CC}=5.0V ± 10%, unless otherwise specified

No	Symbol	Parameter	Z84C0004**		Z84C0006		Z84C0008		Z84C0010		Z84C0020[1]		Unit	Note
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
1	T _c	Clock Cycle time	250*	DC	162*	DC	125*	DC	100*	DC	50*	DC	nS	
2	T _w Ch	Clock Pulse width (high)	110	DC	65	DC	55	DC	40	DC	20	DC	nS	
3	T _w Cl	Clock Pulse width (low)	110	DC	65	DC	55	DC	40	DC	20	DC	nS	
4	T _f C	Clock Fall time		30		20		10		10		10	nS	
5	T _r C	Clock Rise time		30		20		10		10		10	nS	
6	T _d Cr(A)	Address valid from Clock Rise		110		90		80		65		57	nS	[2]
7	T _d A(MREQf)	Address valid to /MREQ Fall	65*		35*		20*		5*		-15*		nS	
8	T _d Cl(MREQf)	Clock Fall to /MREQ Fall delay		85		70		60		55		40	nS	
9	T _d Cr(MREQr)	Clock Rise to /MREQ Rise delay		85		70		60		55		40	nS	
10	T _w MREQh	/MREQ pulse width (High)	110*		65*		45**		30*		10*		nS	[3]
11	T _w MREQl	/MREQ pulse width (low)	220*		132*		100*		75*		25*		nS	[3]
12	T _d Cl(MERQr)	Clock Fall to /MREQ Rise delay		85		70		60		55		40	nS	
13	T _d Cl(RDf)	Clock Fall to /RD Fall delay		95		80		70		65		40	nS	
14	T _d Cr(RDr)	Clock Rise to /RD Rise delay		85		70		60		55		40	nS	
15	T _s D(Cr)	Data setup time to Clock Rise	35		30		30		25		12		nS	
16	T _h D(RDr)	Data hold time after /RD Rise	0		0		0		0		0		nS	
17	T _s WAIT(Cf)	/WAIT setup time to Clock Fall	70		60		50		20		7.5		nS	
18	T _h WAIT(Cf)	/WAIT hold time after Clock Fall	10		10		10		10		10		nS	
19	T _d Cr(M1f)	Clock Rise to /M1 Fall delay		100		80		70		65		45	nS	
20	T _d Cr(M1r)	Clock Rise to /M1 Rise delay		100		80		70		65		45	nS	
21	T _d Cr(RFSHf)	Clock Rise to /RFSH Fall delay		130		110		95		80		60	nS	
22	T _d Cr(RFSHr)	Clock Rise to /RFSH Rise delay		120		100		85		80		60	nS	
23	T _d Cl(RDr)	Clock Fall to /RD Rise delay		85		70		60		55		40	nS	
24	T _d Cr(RDf)	Clock Rise to /RD Fall delay		85		70		60		55		40	nS	
25	T _s D(Cf)	Data setup to Clock Fall during M2, M3, M4 or M5 cycles	50		40		30		25		12		nS	
26	T _d A(IORQf)	Address stable prior to /IORQ Fall	180*		107*		75*		50*		0*		nS	
27	T _d Cr(IORQf)	Clock Rise to /IORQ Fall delay		75		65		55		50		40	nS	
28	T _d Cl(IORQr)	Clock Fall to /IORQ Rise delay		85		70		60		55		40	nS	
29	T _s D(WRf)/Mw	Data stable prior to /WR Fall	80*		22*		5*		40*		-10*		nS	
30	T _d Cl(WRf)	Clock Fall to /WR Fall delay		80		70		60		55		40	nS	
31	T _w WR	/WR pulse width	220*		132*		100*		75*		25*		nS	
32	T _d Cl(WRr)	Clock Fall to /WR Rise delay		80		70		60		55		40	nS	
33	T _d D(WRf)/O	Data stable prior to /WR Fall	-10*		-55*		-55*		-10*		-30*		nS	
34	T _d Cr(WRf)	Clock Rise to /WR Fall delay		65		60		60		50		40	nS	
35	T _s D(WRr)/D	Data stable from /WR Rise	60*		30*		15*		10*		0*		nS	
36	T _d Cl(HALT)	Clock Fall to /HALT 'L' or 'H'		300		260		225		90		70	nS	
37	T _w NMI	/NMI pulse width	80		60		60		60		60		nS	
38	T _s BUSREQ (Cr)	/BUSREQ setup time to Clock Rise	50		50		40		30		15		nS	

*For Clock periods other than the minimums shown, calculate parameters using the table on the following page

Calculated values above assumed TrC = TrC = 20 ns.

†Units in nanoseconds (ns)

†† For loading ≥ 50 pF. Decrease width by 10 ns for each additional 50 pF.

**4 MHz CMOS Z80 is obsolete and replaced by 6 MHz

AC CHARACTERISTICS† (Z84C00/CMOS Z80 CPU; Continued)

V_{CC} = 5.0V ± 10%, unless otherwise specified

No	Symbol	Parameter	Z84C0004**		Z84C0006		Z84C0008		Z84C0010		Z84C0020[1]		Unit	Note
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
39	ThBUSREQ (Cr)	/BUSREQ hold time after Clock Rise	10		10		10		10		10		nS	
40	TdCr (BUSACKf)	Clock Rise to /BASACK Fall delay		100		90		80		75		40	nS	
41	TdCf (BUSACKr)	Clock Fall to /BASACK Rise delay		100		90		80		75		40	nS	
42	TdCr(Dz)	Clock Rise to Data float delay		90		80		70		65		40	nS	
43	TdCr(CTz)	Clock Rise to Control Outputs Float Delay (/MREQ, /IORQ, /RD and /WR)		80		70		60		65		40	nS	
44	TdCr(Az)	Clock Rise to Address float delay		90		80		70		75		40	nS	
45	TdCTr(A)	Address Hold time from /MREQ, /IORQ, /RD or /WR	80*		35*		20*		20*		0*		nS	
46	TsRESET(Cr)	/RESET to Clock Rise setup time	60		60		45		40		15		nS	
47	ThRESET(Cr)	/RESET to Clock Rise Hold time	10		10		10		10		10		nS	
48	TsINTf(Cr)	/INT Fall to Clock Rise Setup Time	80		70		55		50		15		nS	
49	ThINTr(Cr)	/INT Rise to Clock Rise Hold Time	10		10		10		10		10		nS	
50	TdM1f (IORQf)	/M1 Fall to /IORQ Fall delay	565*		359*		270*		220*		100*		nS	
51	TdCf(IORQf)	/Clock Fall to /IORQ Fall delay	85		70		60		55		45		nS	
52	TdCf(IORQr)	Clock Rise to /IORQ Rise delay	85		70		60		55		45		nS	
53	TdCf(D)	Clock Fall to Data Valid delay	150		130		115		110		75		nS	

Notes:

* For Clock periods other than the minimum shown, calculate parameters using the following table.

Calculated values above assumed TrC = TrC = maximum.

** 4 MHz CMOS Z80 is obsolete and replaced by 6 MHz

[1] Z84C0020 parameters are guaranteed with 50pF load Capacitance.

[2] If Capacitive Load is other than 50pF, please use Figure 1. to calculate the value.

[3] Increasing delay by 10nS for each 50pF increase in loading, 200pF max for data lines, and 100pF for control lines.

FOOTNOTES TO AC CHARACTERISTICS

No	Symbol	Parameter	Z84C0004**	Z84C0006	Z84C0008	Z84C0010	Z84C0020
1	TcC	1wCh + TwCl + TrC + TrC					
7	TdA(MREQf)	TwCh + TrC	-65	-50	-45	-45	-45
10	TwMREQh	TwCh + TrC	-20	-20	-20	-20	-20
11	TwMREQl	TcC	-30	-30	-25	-25	-25
26	TdA(IORQf)	TcC	-70	-55	-50	-50	-50
29	TdD(WRf)	1cC	-170	-140	-120	-60	-60
31	TwWR	TcC	-30	-30	-25	-25	-25
33	TdD(WRf)	TwCl + TrC	-140	-140	-120	-60	-60
35	1dWRr(D)	TwCl + TrC	-70	-55	-50	-40	-25
45	1dCTr(A)	TwCl + TrC	-50	-50	-45	-30	-30
50	1dM1f(IORQf)	2TcC + TwCh + TrC	-65	-50	-45	-30	-30

AC Test Conditions: V_{IH} = 2.0 V
V_{IL} = 0.8 V

V_{OH} = 1.5 V
V_{OL} = 1.5 V

V_{IHC} = V_{CC} - 0.6 V
V_{ILC} = 0.45 V

Float = ±0.5 V

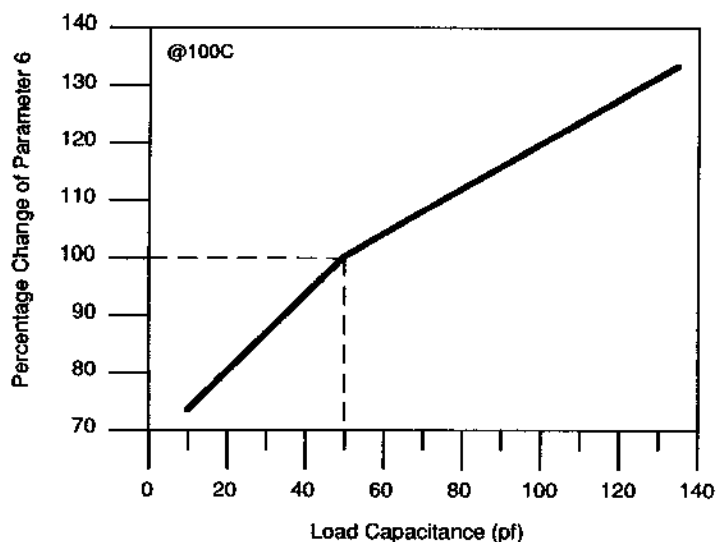


Figure 1. Address Delay Characteristics
(Parameter 6)

DC CHARACTERISTICS (Z8400/NMOS Z80 CPU)

All parameters are tested unless otherwise noted.

Symbol	Parameter	Min	Max	Unit	Test Condition
V_{ILC}	Clock Input Low Voltage	-0.3	0.45	V	
V_{IHC}	Clock Input High Voltage	$V_{CC} - .6$	$V_{CC} + .3$	V	
V_{IL}	Input Low Voltage	-0.3	0.8	V	
V_{IH}	Input High Voltage	2.0 ¹	V_{CC}	V	
V_{OL}	Output Low Voltage		0.4	V	$I_{OL} = 2.0 \text{ mA}$
V_{OH}	Output High Voltage	2.4 ¹		V	$I_{OH} = -250 \mu\text{A}$
I_{CC}	Power Supply Current		200	mA	Note 3
I_{LI}	Input Leakage Current		10	μA	$V_{IN} = 0 \text{ to } V_{CC}$
I_{LO}	3-State Output Leakage Current in Float	-10	10 ²	μA	$V_{OUT} = 0.4 \text{ to } V_{CC}$

1. For military grade parts, refer to the Z80 Military Electrical Specification.

2. A_{15} - A_0 , D_7 - D_0 , $MREQ$, $IORQ$, RD , and WR .

3. Measurements made with outputs floating

CAPACITANCE

Guaranteed by design and characterization.

Symbol	Parameter	Min	Max	Unit
C_{CLOCK}	Clock Capacitance		35	pf
C_{IN}	Input Capacitance		5	pf
C_{OUT}	Output Capacitance		15	pf

NOTES:

$T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$.

Unmeasured pins returned to ground.

AC CHARACTERISTICS† (Z8400/NMOS Z80 CPU)

Number	Symbol	Parameter	Z0840004		Z0840006		Z0840008	
			Min	Max	Min	Max	Min	Max
1	TcC	Clock Cycle Time	250*		162*		125*	
2	TwCh	Clock Pulse Width (High)	110	2000	65	2000	55	2000
3	TwCl	Clock Pulse Width (Low)	110	2000	65	2000	55	2000
4	TfC	Clock Fall Time		30		20		10
5	TrC	Clock Rise Time		30		20		10
6	TdCr(A)	Clock ↑ to Address Valid Delay		110		90		80
7	TdA(MREQ)	Address Valid to $\overline{\text{MREQ}}$ ↓ Delay	65*		35*		20*	
8	TdCl(MREQ)	Clock ↓ to $\overline{\text{MREQ}}$ ↓ Delay		85		70		60
9	TdCr(MREQ)	Clock ↑ to $\overline{\text{MREQ}}$ ↑ Delay		85		70		60
10	TwMREQh	$\overline{\text{MREQ}}$ Pulse Width (High)	110*††		65*††		45*††	
11	TwMREQl	$\overline{\text{MREQ}}$ Pulse Width (Low)	220*††		135*††		100*††	
12	TdCl(MREQ)	Clock ↓ to $\overline{\text{MREQ}}$ ↑ Delay		85		70		60
13	TdCl(RD)	Clock ↓ to $\overline{\text{RD}}$ ↓ Delay		95		80		70
14	TdCr(RD)	Clock ↑ to $\overline{\text{RD}}$ ↑ Delay		85		70		60
15	TsD(Cr)	Data Setup Time to Clock ↑	35		30		30	
16	ThD(RD)	Data Hold Time to $\overline{\text{RD}}$ ↑		0		0		0
17	TsWAIT(Cf)	$\overline{\text{WAIT}}$ Setup Time to Clock ↓	70		60		50	
18	ThWAIT(Cf)	$\overline{\text{WAIT}}$ Hold Time after Clock ↓		0		0		0
19	TdCr(M1f)	Clock ↑ to $\overline{\text{M1}}$ ↓ Delay		100		80		70
20	TdCr(M1r)	Clock ↑ to $\overline{\text{M1}}$ ↑ Delay		100		80		70
21	TdCr(RFSHf)	Clock ↑ to $\overline{\text{RFSH}}$ ↓ Delay		130		110		95
22	TdCr(RFSHr)	Clock ↑ to $\overline{\text{RFSH}}$ ↑ Delay		120		100		85
23	TdCl(RD)	Clock ↓ to $\overline{\text{RD}}$ ↑ Delay		85		70		60
24	TdCr(RD)	Clock ↑ to $\overline{\text{RD}}$ ↓ Delay		85		70		60
25	TsD(Cf)	Data Setup to Clock ↓ during M ₂ , M ₃ , M ₄ , or M ₅ Cycles	50		40		30	
26	TdA(IORQ)	Address Stable prior to $\overline{\text{IORQ}}$ ↓	180*		110*		75*	
27	TdCr(IORQ)	Clock ↑ to $\overline{\text{IORQ}}$ ↓ Delay		75		65		55
28	TdCl(IORQ)	Clock ↓ to $\overline{\text{IORQ}}$ ↑ Delay		85		70		60
29	TdD(WRf)	Data Stable prior to $\overline{\text{WR}}$ ↓	80*		25*		5*	
30	TdCl(WRf)	Clock ↓ to $\overline{\text{WR}}$ ↓ Delay		80		70		60
31	TwWR	$\overline{\text{WR}}$ Pulse Width	220*		135*		100*	
32	TdCl(WRr)	Clock ↓ to $\overline{\text{WR}}$ ↑ Delay		80		70		60
33	TdD(WRf)	Data Stable prior to $\overline{\text{WR}}$ ↓	-10*		-55*		55*	
34	TdCr(WRf)	Clock ↑ to $\overline{\text{WR}}$ ↓ Delay		65		60		55
35	TdWRr(D)	Data Stable from $\overline{\text{WR}}$ ↑	60*		30*		15*	
36	TdCr(HALT)	Clock ↓ to $\overline{\text{HALT}}$ ↑ or ↓		300		260		225
37	TwNMI	$\overline{\text{NMI}}$ Pulse Width	80		70		60*	
38	TsBUSREQ(Cr)	$\overline{\text{BUSREQ}}$ Setup Time to Clock ↑	50		50		40	

*For clock periods other than the minimums shown, calculate parameters using the table on the following page. Calculated values above assumed TrC = TfC = 20 ns.

†Units in nanoseconds (ns).

†† For loading ≥ 50 pF., Decrease width by 10 ns for each additional 50 pF.

AC CHARACTERISTICS† (Z8400/NMOS Z80 CPU; Continued)

Number	Symbol	Parameter	Z0840004		Z0840006		Z0840008	
			Min	Max	Min	Max	Min	Max
39	ThBUSREQ(Cr)	BUSREQ Hold Time after Clock ↑	0		0		0	
40	TdCr(BUSACKf)	Clock ↑ to $\overline{\text{BUSACK}}$ ↓ Delay		100		90		80
41	TdCr(BUSACKr)	Clock ↓ to $\overline{\text{BUSACK}}$ ↑ Delay		100		90		80
42	TdCr(Dz)	Clock ↑ to Data Float Delay		90		80		70
43	TdCr(CTz)	Clock ↑ to Control Outputs Float Delay ($\overline{\text{MREQ}}$, $\overline{\text{IORQ}}$, $\overline{\text{RD}}$, and $\overline{\text{WR}}$)		80		70		60
44	TdCr(Az)	Clock ↑ to Address Float Delay		90		80		70
45	TdCTr(A)	$\overline{\text{MREQ}}$ ↑, $\overline{\text{IORQ}}$ ↑, $\overline{\text{RD}}$ ↑, and $\overline{\text{WR}}$ ↑ to Address Hold Time	80*		35*		20*	
46	TsRESET(Cr)	$\overline{\text{RESET}}$ to Clock ↑ Setup Time	60		60		45	
47	ThRESET(Cr)	$\overline{\text{RESET}}$ to Clock ↑ Hold Time		0		0		0
48	TsINTf(Cr)	$\overline{\text{INT}}$ to Clock ↑ Setup Time	80		70		55	
49	ThINTr(Cr)	$\overline{\text{INT}}$ to Clock ↑ Hold Time		0		0		0
50	TdM1f(IORQf)	$\overline{\text{M1}}$ ↑ to $\overline{\text{IORQ}}$ ↓ Delay	565*		365*		270*	
51	TdCr(IORQf)	Clock ↑ to $\overline{\text{IORQ}}$ ↓ Delay		85		70		60
52	TdCr(IORQr)	Clock ↑ to $\overline{\text{IORQ}}$ ↑ Delay		85		70		60
53	TdCr(D)	Clock ↓ to Data Valid Delay		150		130		115

*For clock periods other than the minimums shown, calculate parameters using the following table. Calculated values above assumed $\text{TrC} = \text{TfC} = 20 \text{ ns}$.

†Units in nanoseconds (ns).

FOOTNOTES TO AC CHARACTERISTICS

Number	Symbol	General Parameter	Z0840004	Z0840006	Z0840008
†	TcC	$\text{TwCh} + \text{TwCl} + \text{TrC} + \text{TfC}$			
7	TdA(MREQf)	$\text{TwCh} + \text{TfC}$	~ 65	~ 50	~ 45
10	TwMREQh	$\text{TwCh} + \text{TfC}$	~ 20	~ 20	~ 20
11	TwMREQl	TcC	~ 30	~ 30	~ 25
26	TdA(IORQf)	TcC	~ 70	~ 55	~ 50
29	TdD(WRf)	TcC	~ 170	~ 140	~ 120
31	TwWR	TcC	~ 30	~ 30	~ 25
33	TdD(WRf)	$\text{TwCl} + \text{TrC}$	~ 140	~ 140	~ 120
35	TdWRr(D)	$\text{TwCl} + \text{TrC}$	~ 70	~ 55	~ 50
45	TdCTr(A)	$\text{TwCl} + \text{TrC}$	~ 50	~ 50	~ 45
50	TdM1f(IORQf)	$2\text{TcC} + \text{TwCh} + \text{TfC}$	~ 65	~ 50	~ 45

AC Test Conditions:

$V_{IH} = 2.0 \text{ V}$

$V_{IL} = 0.8 \text{ V}$

$V_{IHC} = V_{CC} - 0.6 \text{ V}$

$V_{ILC} = 0.45 \text{ V}$

$V_{OH} = 1.5 \text{ V}$

$V_{OL} = 1.5 \text{ V}$

FLOAT = $\pm 0.5 \text{ V}$